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(12) **United States Design Patent** (10) **Patent No.:** **US D1,001,773 S**  
**Lin et al.** (45) **Date of Patent:** **\*\* Oct. 17, 2023**

(54) **HEADPHONE**

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(\*\*) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (14) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
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(58) **Field of Classification Search**  
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381/380–381, 378, 374  
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H04R 1/1016; H04R 1/10; H04R 5/033;  
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See application file for complete search history.

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*Primary Examiner* — Paula Allen Greene

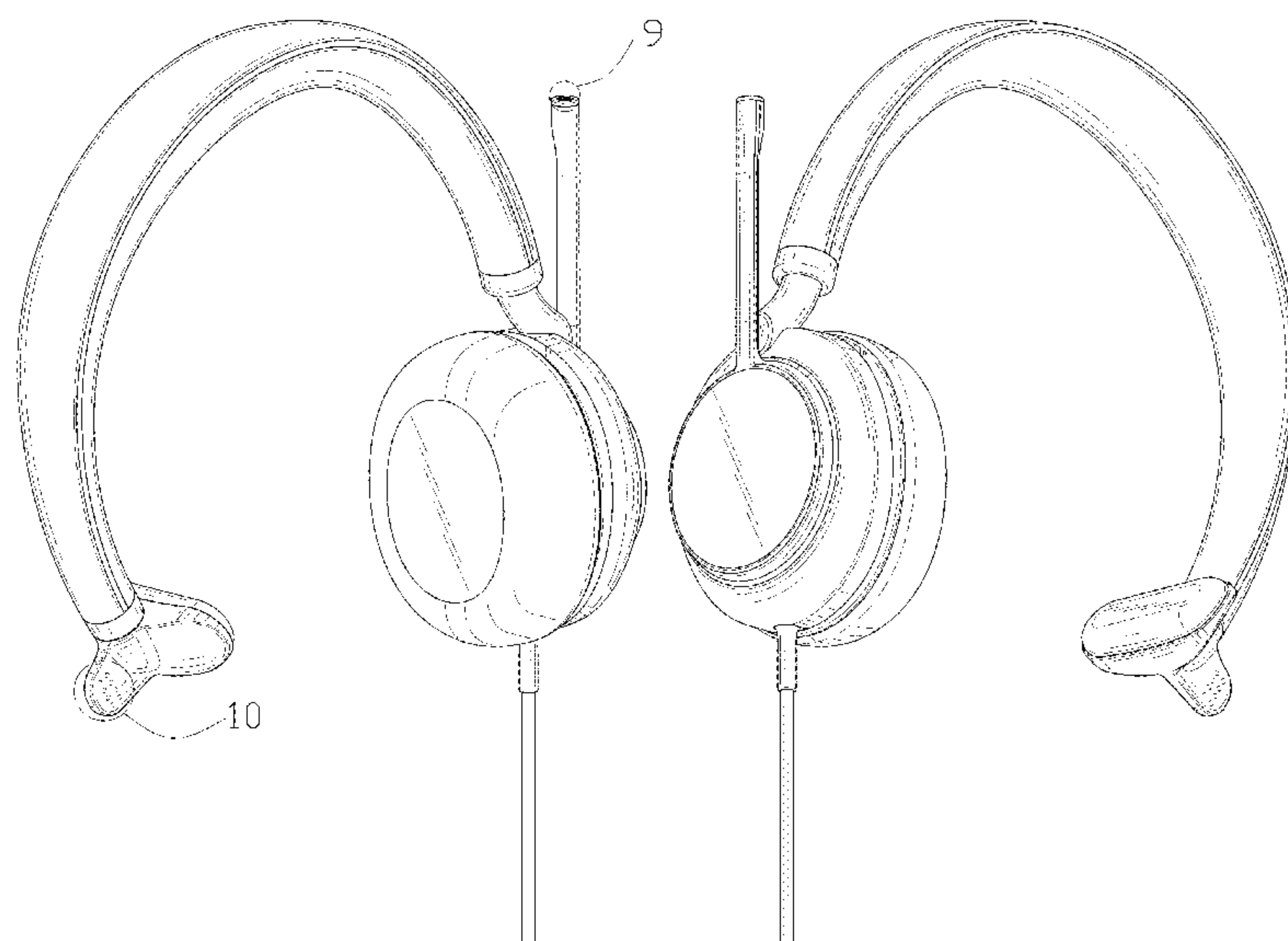
(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, front, and left side perspective view of a headphone showing our new design;  
FIG. 2 is a bottom, rear and right side perspective view thereof;  
FIG. 3 is a front elevational view thereof;  
FIG. 4 is a rear elevational view thereof;  
FIG. 5 is a left side view thereof;  
FIG. 6 is a right side view thereof;  
FIG. 7 is a top plan view thereof;  
FIG. 8 is a bottom plan view thereof;  
FIG. 9 is an enlarged view of portion 9 in FIG. 1; and,  
FIG. 10 is an enlarged view of portion 10 in FIG. 1.  
The broken lines in the drawings illustrate portions of the headphone which form no part of the claimed design.  
The dot-dash broken lines encircling portions of the headphone in FIG. 1 and illustrated in enlarged views in FIGS. 9 and 10 and forms no part of the claimed design.

**1 Claim, 10 Drawing Sheets**



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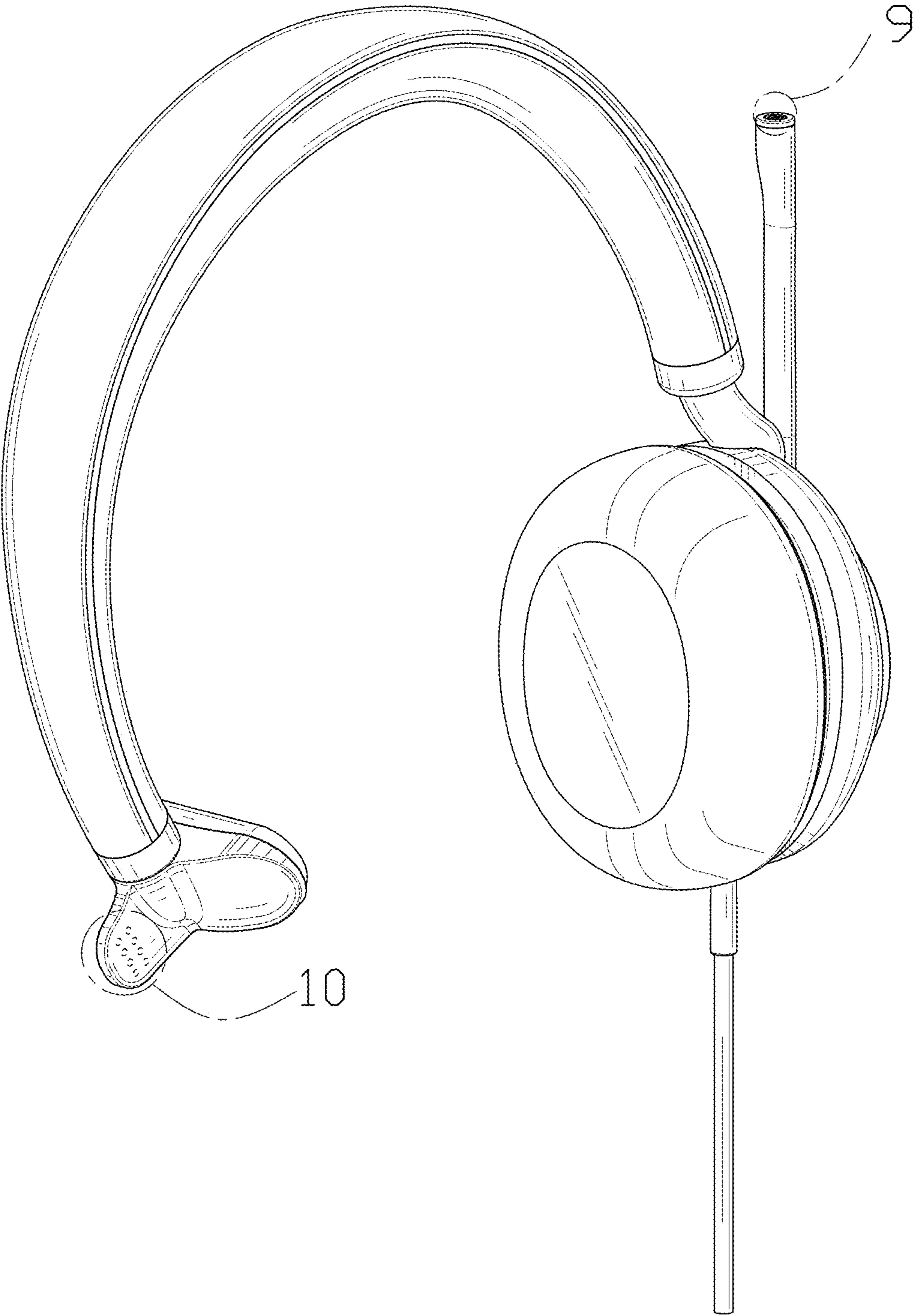


FIG. 1

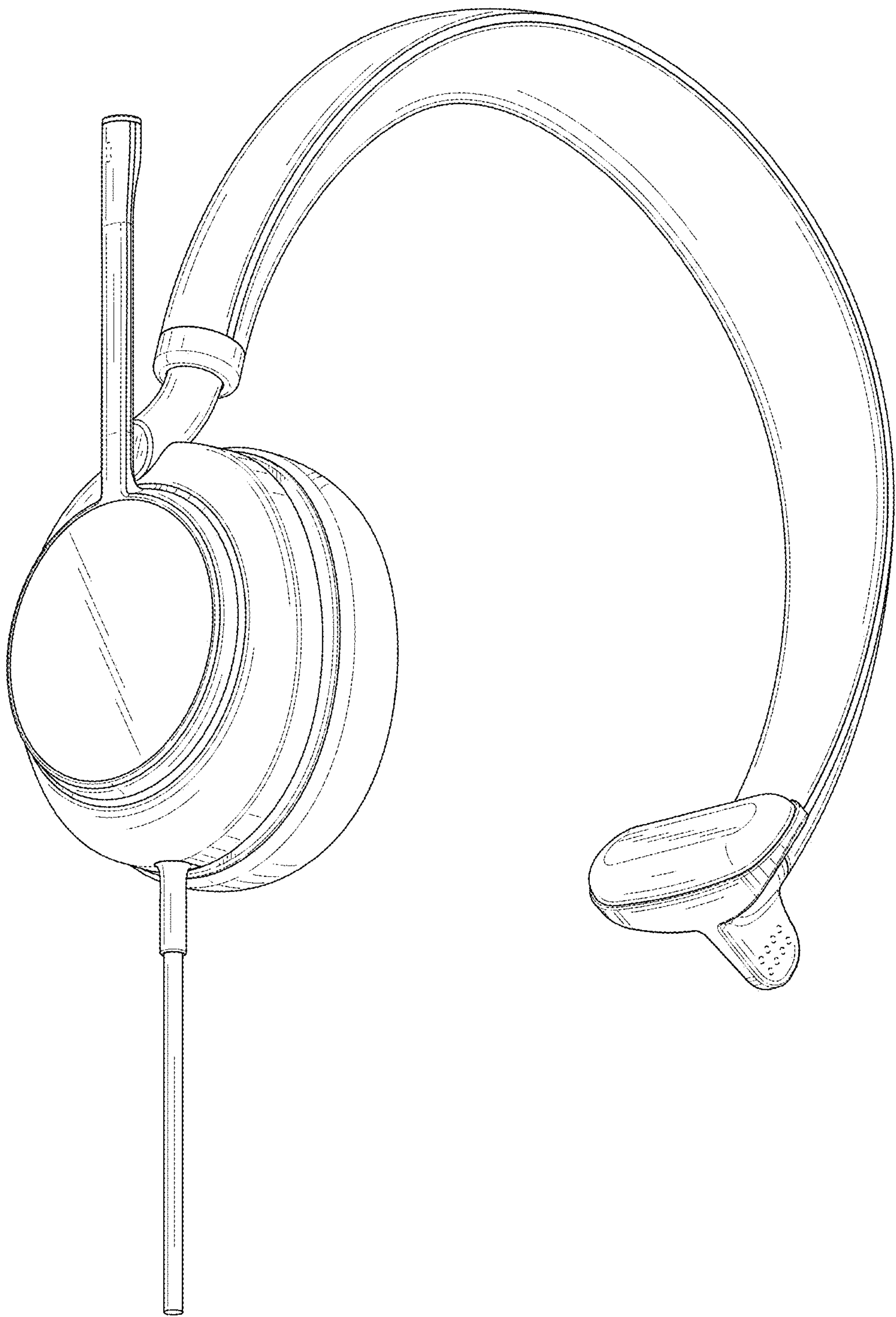


FIG. 2

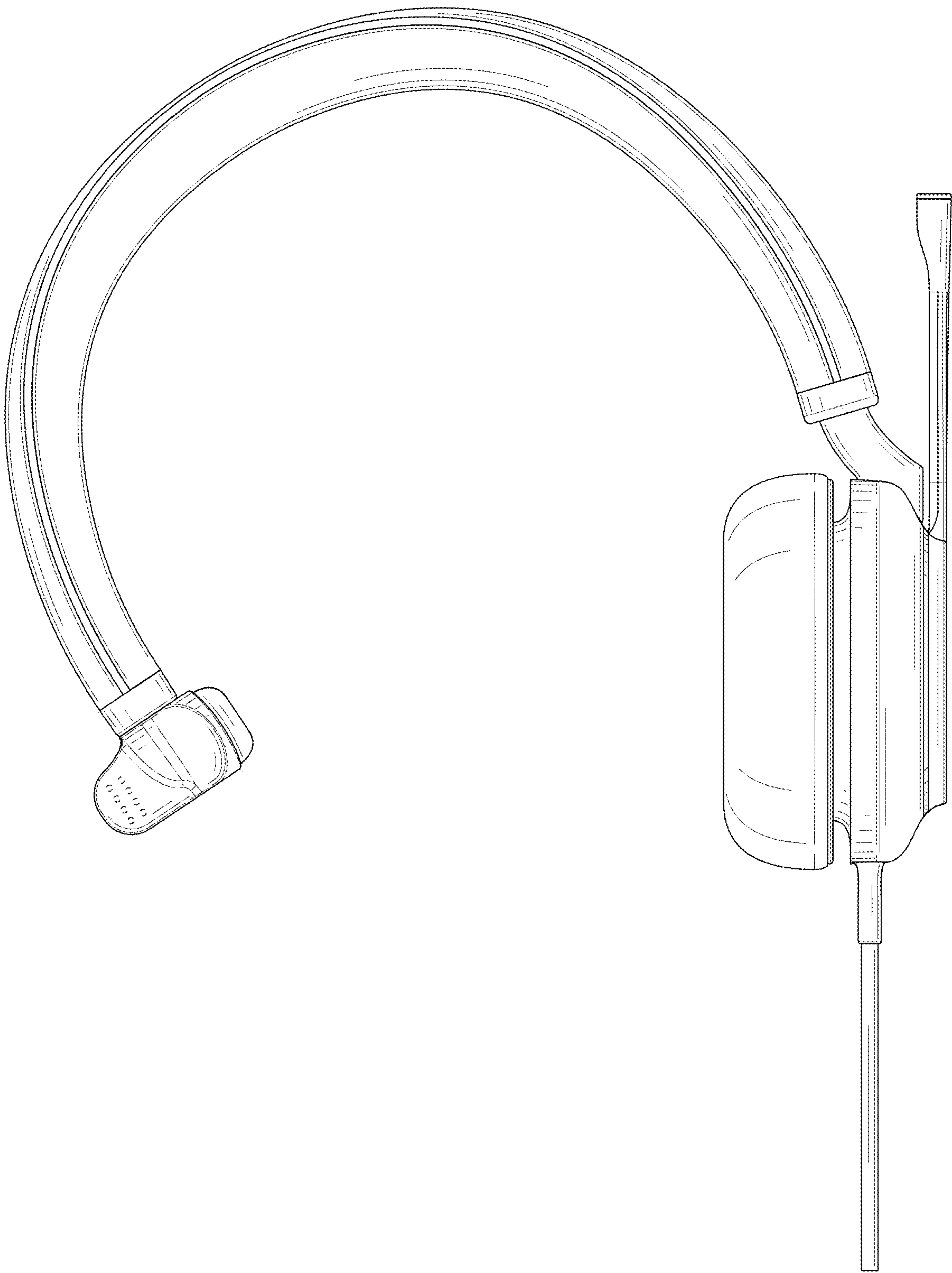


FIG. 3

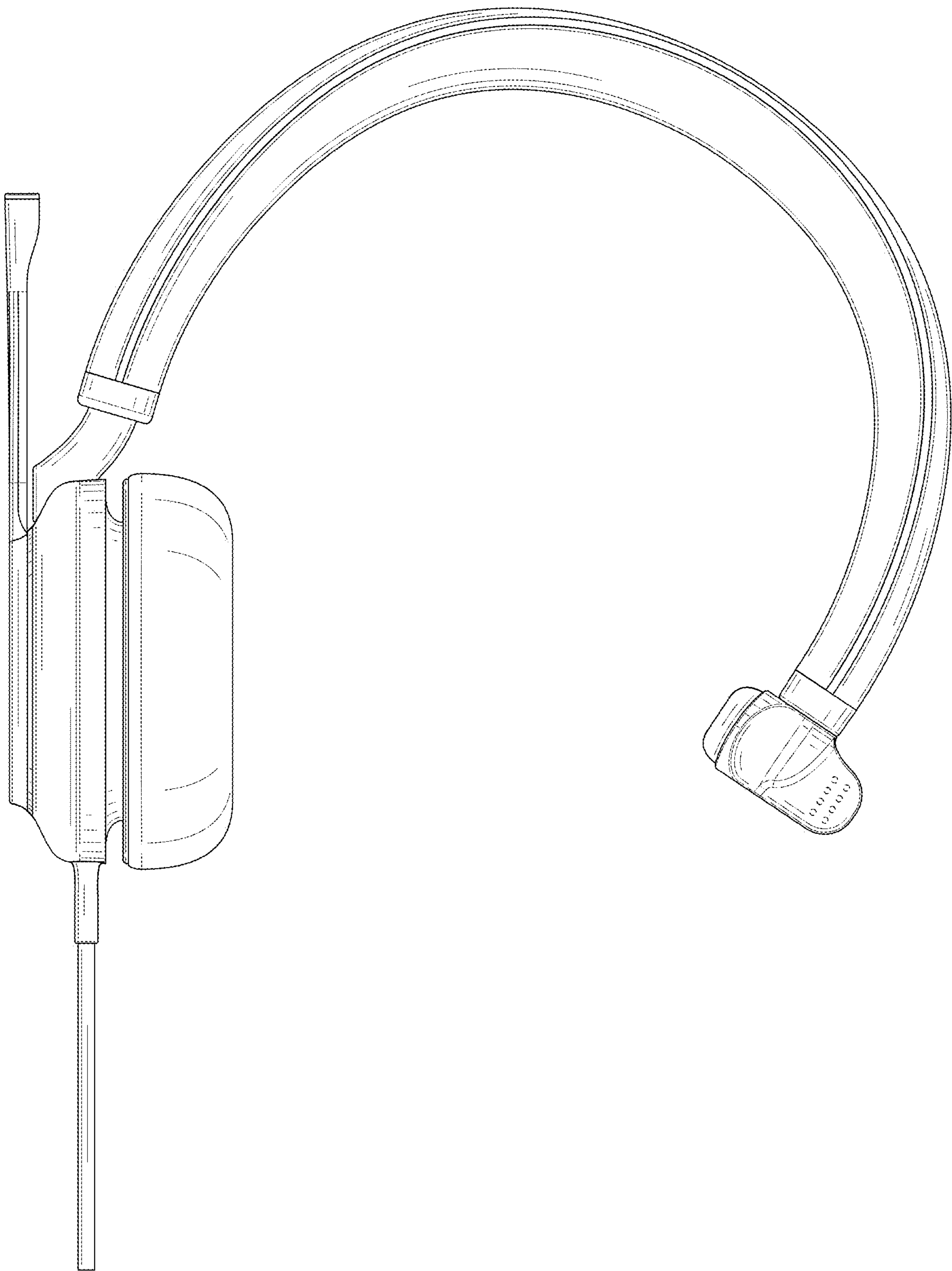


FIG. 4

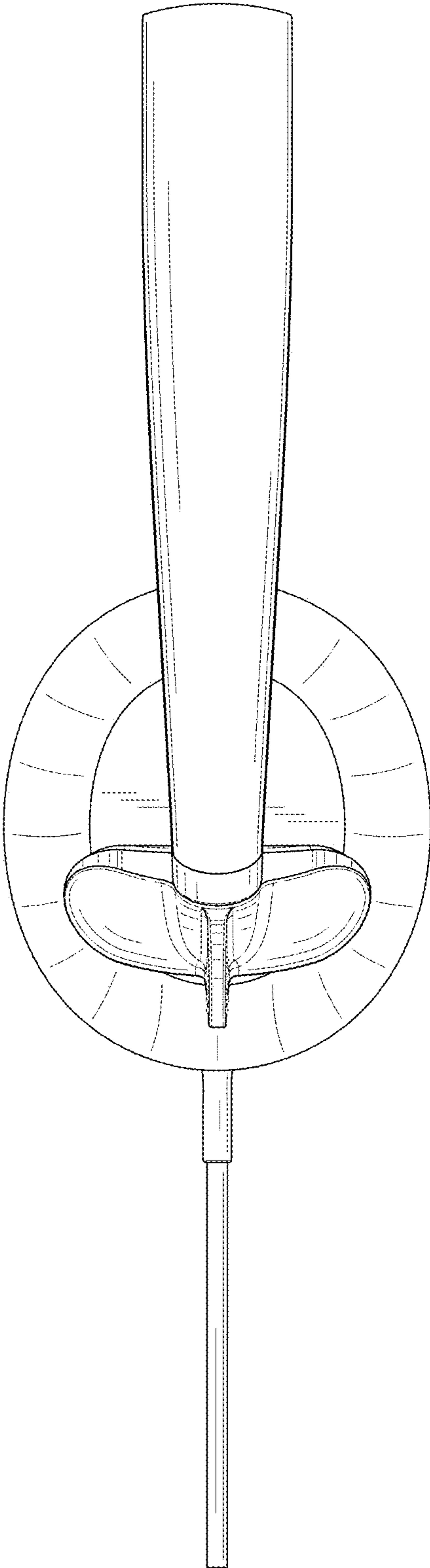


FIG. 5

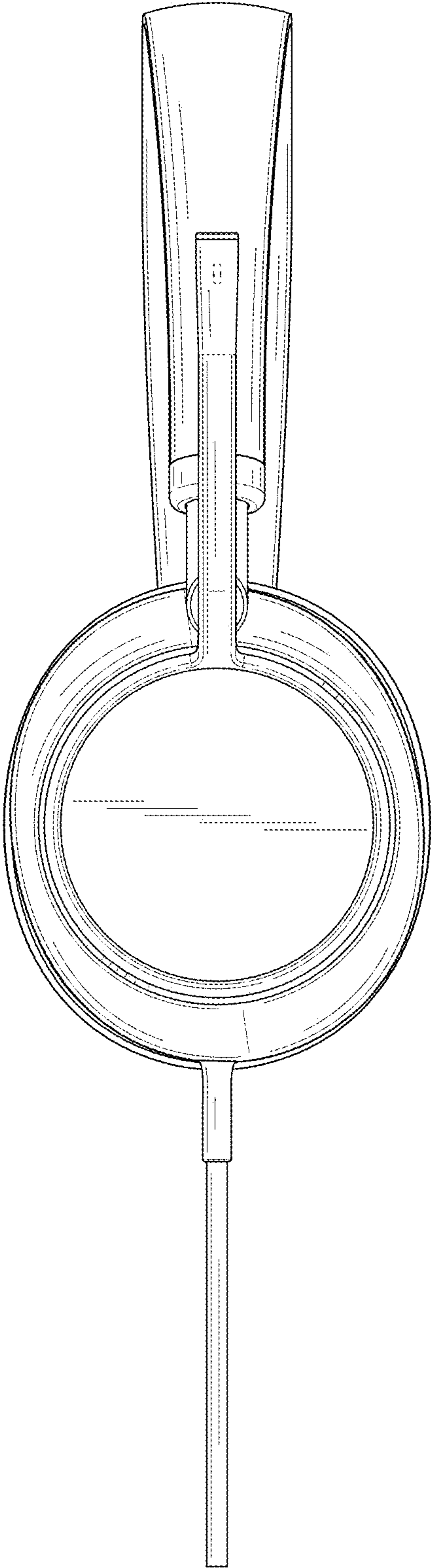


FIG. 6

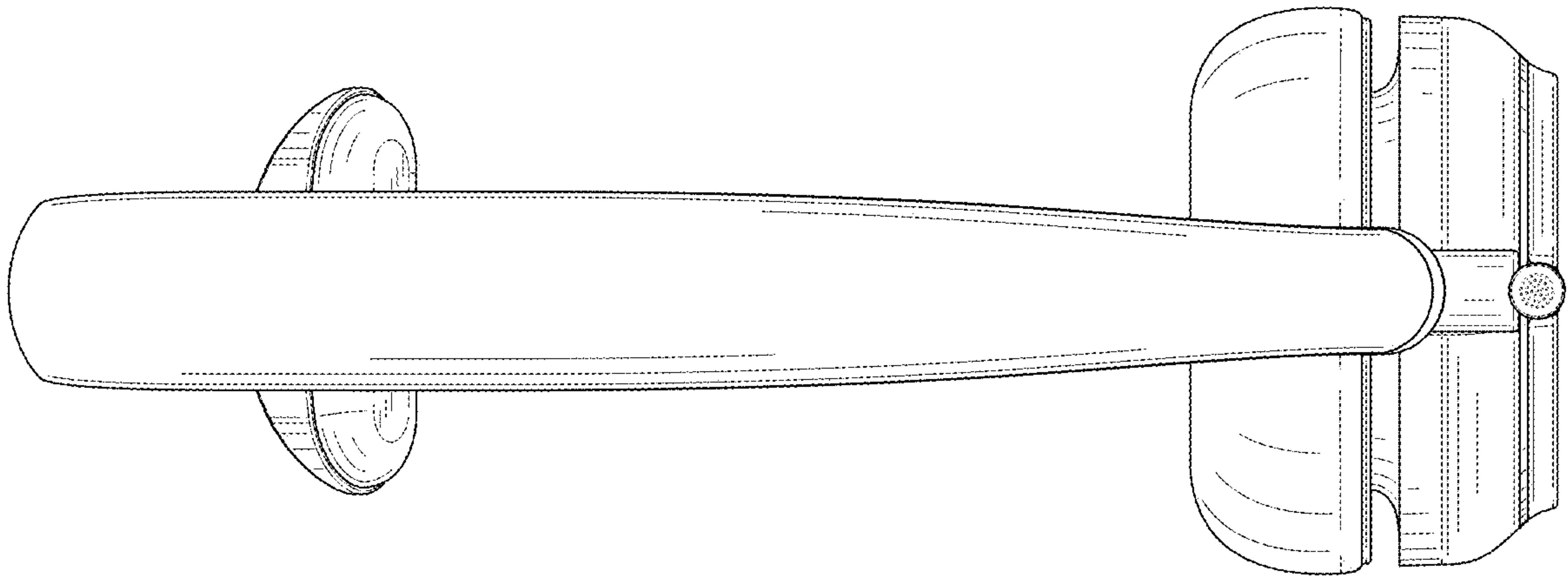


FIG. 7

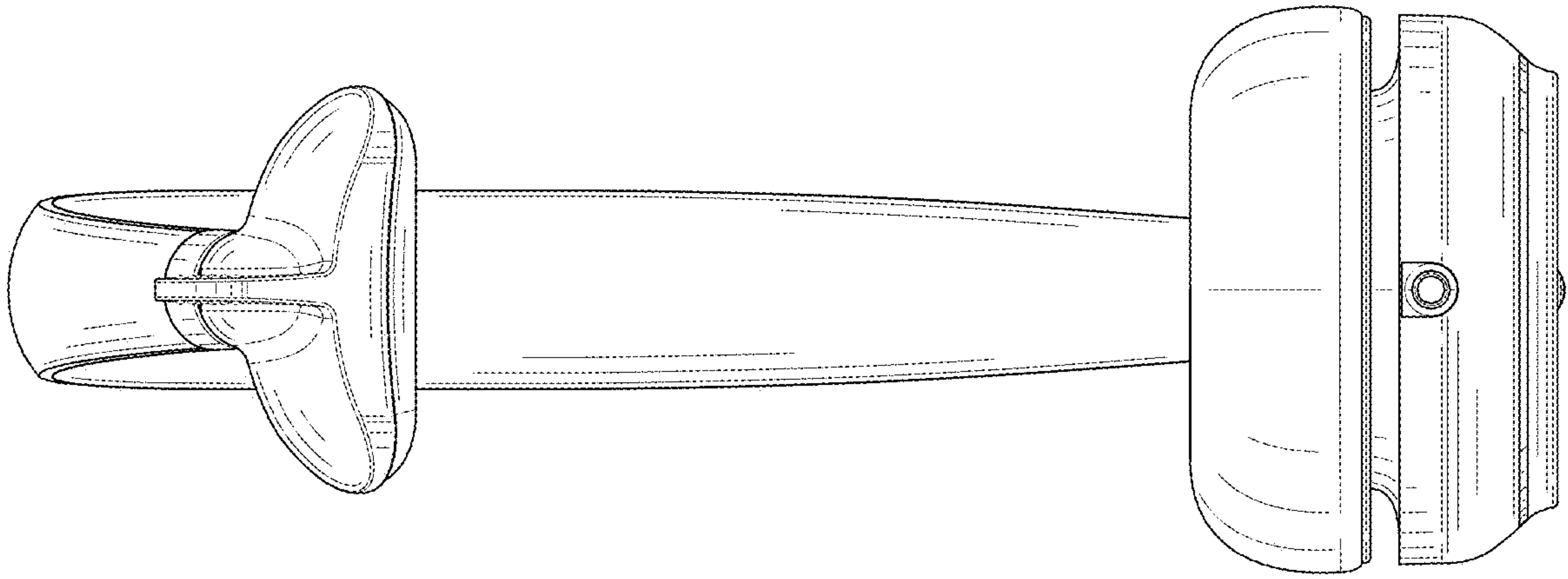


FIG. 8

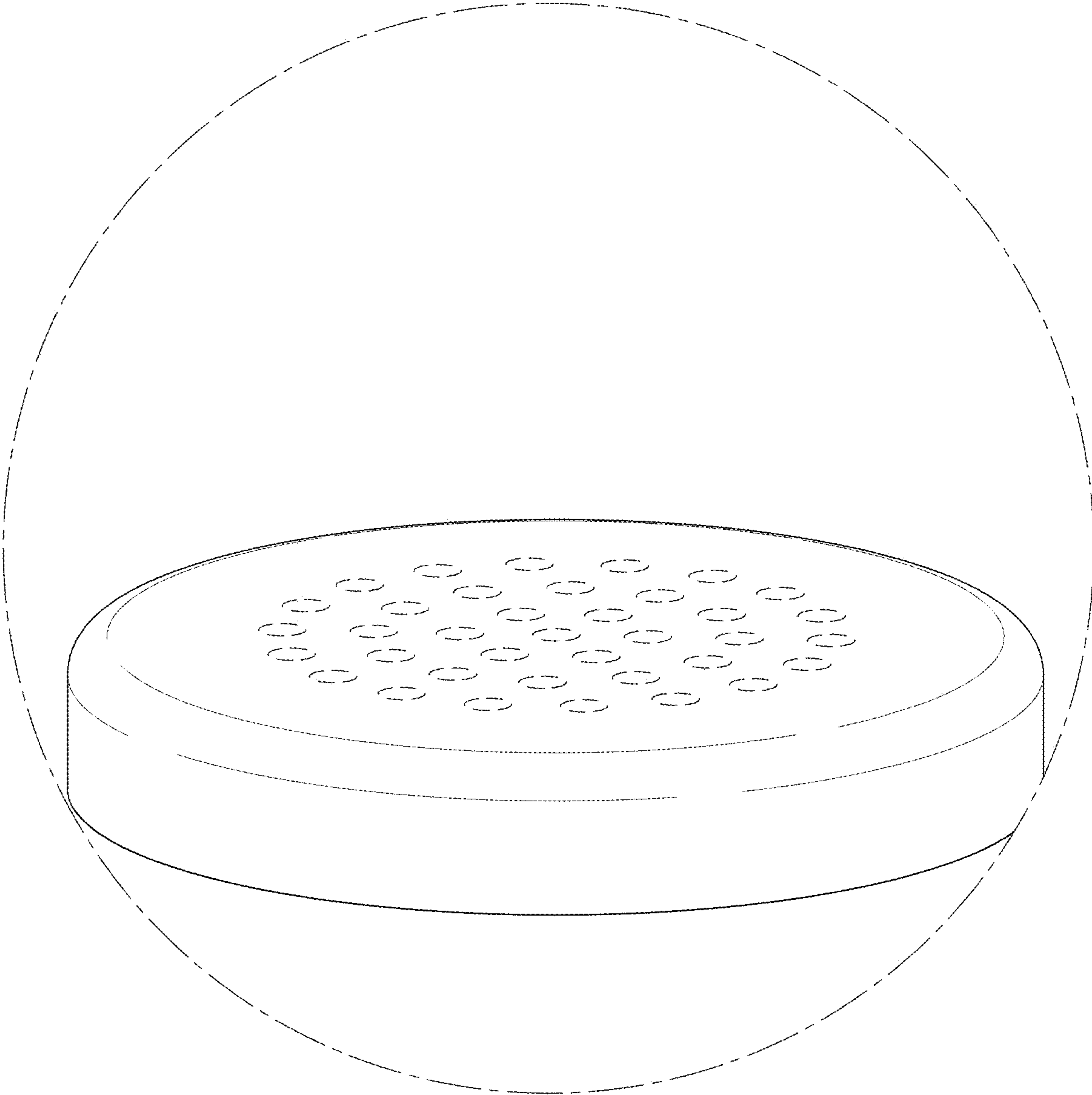


FIG. 9

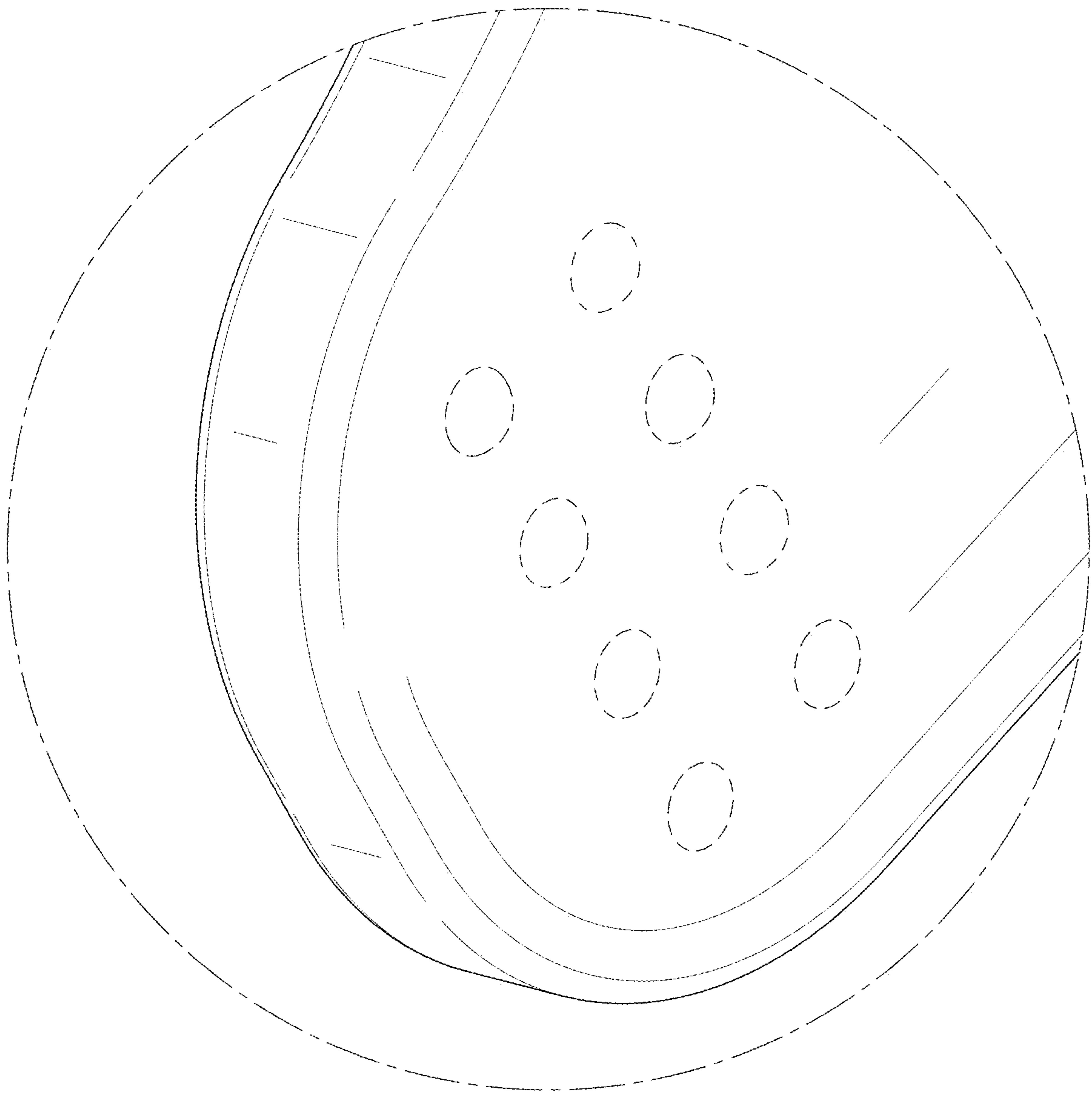


FIG. 10